

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

1t1469is8-2#trpbf

(Engineering Calculation)

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**TOTAL MASS (g) : 0.134157**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.003222	1000000	24016.5566406		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000134	1000000	998.82635498		
Lead Frame	A42	Copper (Cu)	7440-50-8	0.000000	0	0		
		Iron (Fe)	7439-89-6	0.025972	580000	193593.421875		
		Phosphorus (P)	7723-14-0	0.000000	0	0		
		Zinc (Zn)	7440-66-6	0.000000	0	0		
		Nickel (Ni)	7440-02-0	0.018808	420000	140193.484375		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
<b>Lead Frame Total:</b>				<b>0.044780</b>	<b>1000000</b>	<b>333786.90625</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.002585	1000000	19271.6660156		
		<b>External Plating Total:</b>				<b>0.002585</b>	<b>1000000</b>	<b>19271.6660156</b>
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000358	1000000	2668.50634766		
<b>Internal Plating Total:</b>				<b>0.000358</b>	<b>1000000</b>	<b>2668.50634766</b>		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000948	750000	7066.32373047		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000316	250000	2355.44116211		
<b>Die Attach Total:</b>				<b>0.001264</b>	<b>1000000</b>	<b>9421.76464844</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.010590	130000	78937.1015625		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.067613	830000	503982.4375		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.002851	35000	21251.1503906		
		Carbon Black (C)	1333-86-4	0.000407	5000	3033.7487793		
		<b>Encapsulation Total:</b>				<b>0.081461</b>	<b>1000000</b>	<b>607204.4375</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000353	1000000	2631.23681641		
					<b>TOTAL MASS (g) :</b>	<b>0.134157</b>		